

**In The United States Patent and Trademark Office
On Appeal from the Examiner to the Board
of Patent Appeals and Interferences**

In re Application of: Albert (nmi) Chan
Serial No.: 10/663,207
Filing Date: September 15, 2003
Group Art Unit: 1733
Confirmation No.: 2364
Examiner: John L. Goff II
Title: Thermal Interface Adhesive

Mail Stop: Appeal Brief - Patents

Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

Dear Sir:

REQUEST FOR STATUS

Please advise of the status of the above-identified patent application. A Reply Brief in response to the Examiner's Answer mailed December 13, 2007 was filed by Appellant on January 2, 2008. Appellant is currently awaiting a decision from the Board of Patent Appeals and Interferences.

If there are any matters that can be resolved through a telephone conference, please contact the undersigned attorney for Appellant at the telephone number listed below.

Respectfully submitted,

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Brian W. Oaks
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Date: April 17, 2008

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